

# ZIITEK ELECTRONIC MATERIAL & TECHNOLOGY CO.,LTD

## TIF<sup>™</sup>100-10UF Thermally Conductive Gap Filler Pads Series

REV02



### **Features**

- Sood thermal conductivity: 1.5 W/mK
- » Naturally tacky needing no further adhesive coating
- Soft and Compressible for low stress applications
- » Available in varies thickness

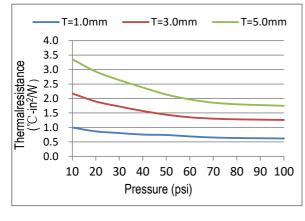
### **Application**

- Cooling components to the chassis of frame
- Set Top Box
- » Car Battery & Power Supply
- » Charging Pile
- » LED TV/ Lighting
- » Graphics Card Thermal Module

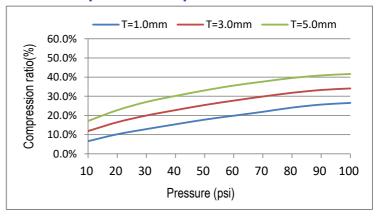
TIF<sup>TM</sup>100-10UF Series thermally conductive interface materials are applied to fill the air gaps between the heating elements and the heat dissipation fins or the metal base. Their flexibility and elasticity make them suited to coat very uneven surfaces. Heat can transmit to the metal housing or dissipation plate from the heating elements or even the entire PCB, which effecitly enhances the efficiency and life-time of the heat-generating electronic components.

Typical Properties of TIF <sup>™</sup> 100-10UF Series		
Color	Gray	Visual
Construction	Ceramic filled silicone elastomer	******
Thickness range	0.020"(0.5mm)~0.200" (5.0mm)	ASTM D374
Hardness	75 Shore 00	ASTM 2240
Specific Gravity	2.2 g/cc	ASTM D297
Operating Temp	-40 ~160 ℃	*******
Dielectric Breakdown Voltage	>5500 VAC	ASTM D149
Dielectric Constant@1MHz	3.9 MHz	ASTM D150
Volume Resistivity	1.0X10 <sup>12</sup> Ohm-cm	ASTM D257
Thermal Conductivity	1.5 W/mK	ASTM D5470
	1.5 W/mK	GB-T32064
Outgassing (TML)	0.35%	ASTM E595
Flame Rating	94 -V0	UL E331100

# psi. vs.Thermal Resistance



## psi. vs. Compression Ratio



# Product Identification: Product Number Thickness: 20-200mils FG: With Fiberglass Thermal Conductivity: 1.5W/mK Thermal Conductivity: 1.5W/mK Tiff 00 FG - 15 - 10 UF - NS1 - A1 Application Technology Download Thermal Conductive Interface Materials A1: Adhesive on one side NS1: Single sided coating Hardness: UF-Hard Color: 10(Gray)

**Product Specification** 

http://www.ziitek.com

**Product Thicknesses:** 0.020-inch to 0.200-inch (0.5mm to 5.0mm) **Product Sizes:** 8" x 16"(203mm x406mm) Individual die cut shapesand and custom thickness can be supplied. Please contact us for confirming

Thermally Conductive Materials Heat Generating Materials Thermally Conductive Plastics Foaming Silica Gel Die-Cutting Products

Canada: Taiwan:

Tel:+001-604-2998559 E-mail: sales@thermazig.com China: Tel: +86-769-38801208 E-mail: frances@ziitek.com.tw Taiwan:
Tel:+886-2-22771007
E-mail:frances@ziitek.com.tw